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## **NEXX Systems Names Tsuyoshi Kotaki As Sales Director, Japan Region**

**Billerica, MA – June 23, 2009** – NEXX Systems, a leading provider of processing equipment for advanced wafer-level packaging applications, today announced that it has named Tsuyoshi (Yoshi) Kotaki to serve as the Sales Director, Japan Region, heading the Company's customer-related operations in that region. Mr. Kotaki will work closely with NEXX's valuable trading partner, Kanematsu Corporation, to bring electroplating and sputtered metal solutions to the rapidly growing 3D packaging market in Japan. Mr. Kotaki comes to NEXX with extensive sales experience in the Japanese semiconductor equipment market, most recently at Novellus, where he was account director for ten years to many of the major semiconductor corporations in Japan. Prior to Novellus, he served at Varian, following 20 years at Seki Technotron representing many key companies in the semiconductor market. Mr. Kotaki holds a bachelor of commerce (economics) degree from Kanagawa University.

Stated John Bowers, Vice President of Sales and Business Development for NEXX Systems, "We are delighted to have Kotaki-san join the NEXX team. He brings a wealth of experience in both semiconductor business and the Japanese marketplace. His deep insights, customer knowledge, and energy will serve to grow NEXX's presence in the Japanese semiconductor arena."

Mr. Kotaki added, "I am looking forward to expanding the opportunities for NEXX to serve the Japanese market with our innovative product offering. Enabling the success of our customers will bring faster, smarter devices to the consumer – and that success will be driven by technologies and equipment produced by NEXX."

**About NEXX:** NEXX Systems brings exceptional technical expertise to the flip chip and advanced packaging markets. Our product lines provide the most efficient, yet affordable, systems of their kind: Stratus for high throughput electro-deposition of metals, and Apollo and Nimbus for multi-layer sputter deposition of metals. Additional information can be found at: [www.nexxsystems.com](http://www.nexxsystems.com).

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